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Laser Micromachining Technologies

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Manufacturing Technology Conference Tech Talk





Contents

- GF Machining Solutions technology portfolio and markets.
- Laser micro-engraving applications.
- Laser micro-cutting and micro-drilling applications.
- Key takeaways.





GF Machining Solutions: a global partner close to you

In 2023:



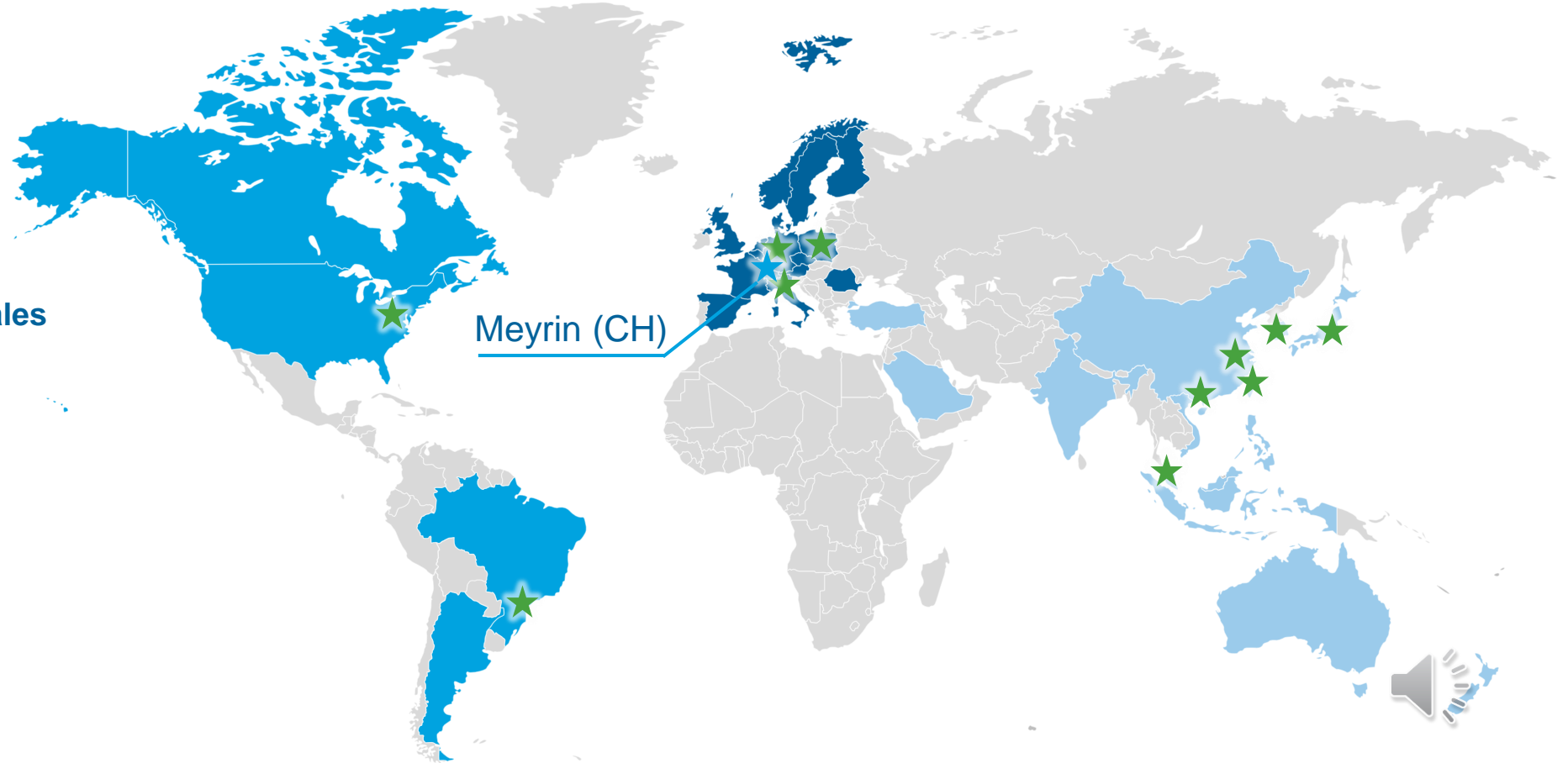
887
Million CHF in Sales



3 377
employees



41 countries



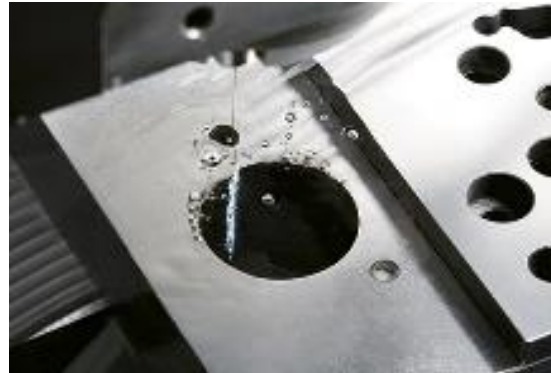


Unique **TECHNOLOGY** portfolio

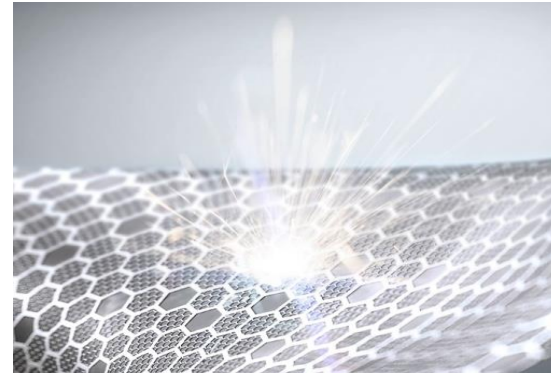
Milling



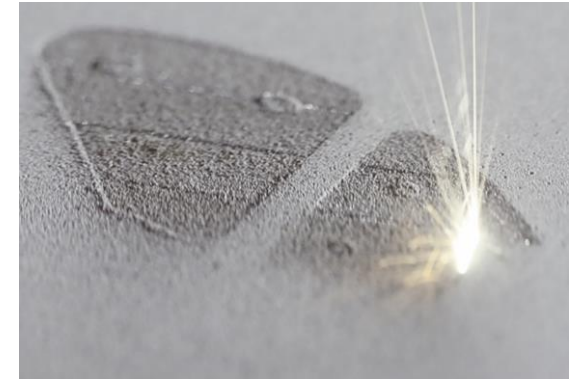
EDM



Laser and Micromachining



Additive Manufacturing



Spindles



Tooling and Automation



Digital Business



Services and Training

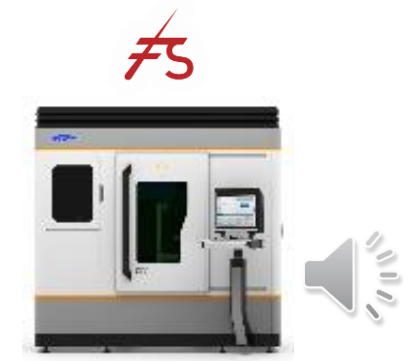
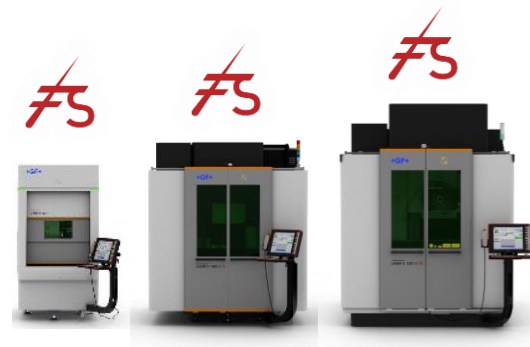
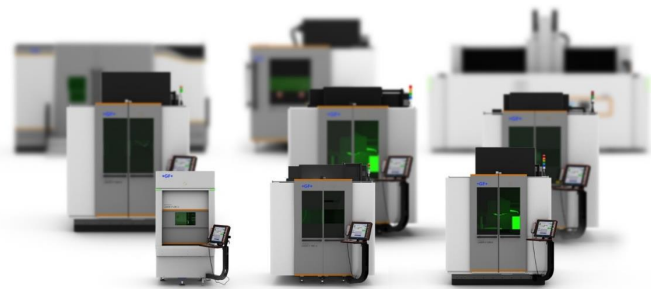
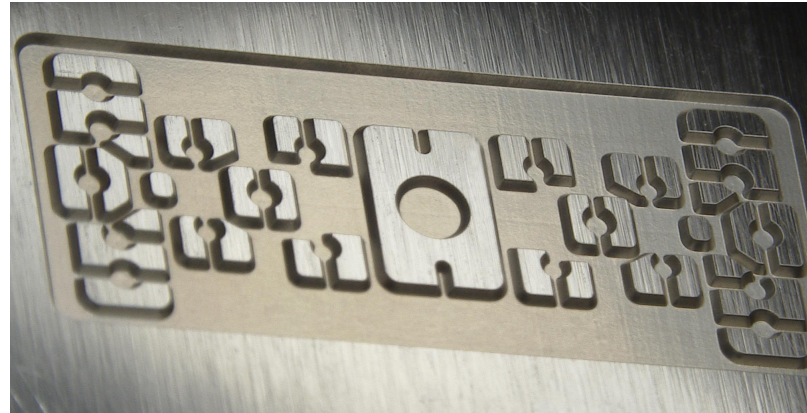


+ Unique **LASER** portfolio

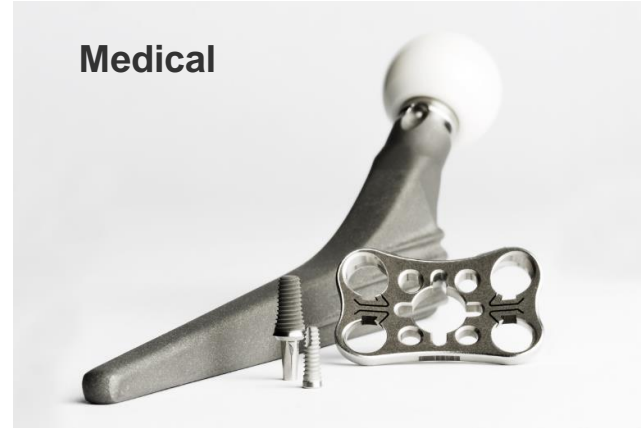
3D Surface Processing



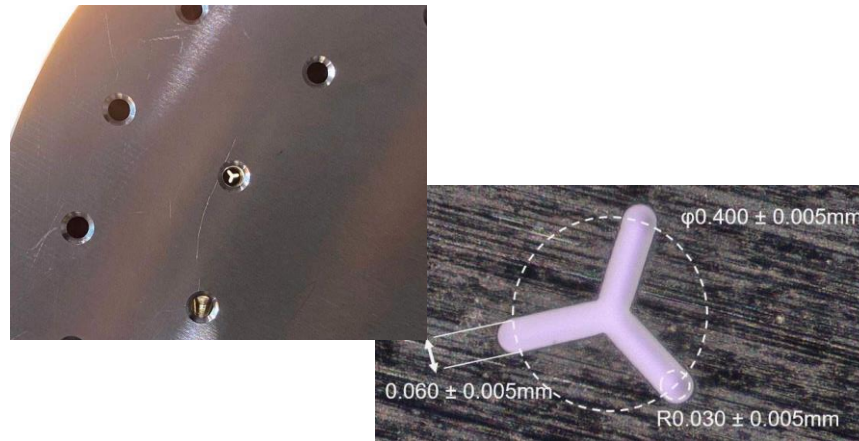
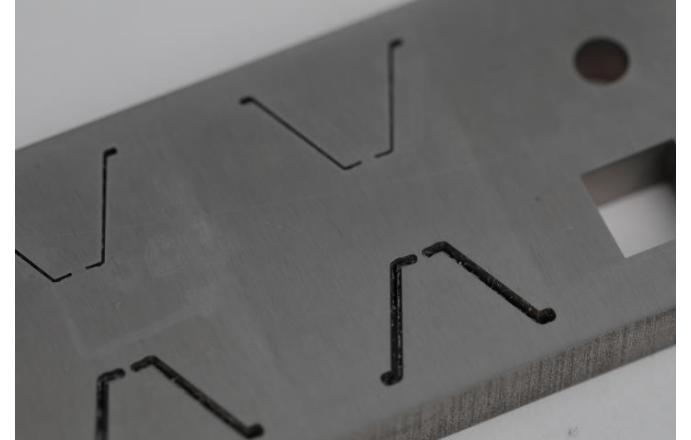
Micromachining



+ 3D Surface Processing



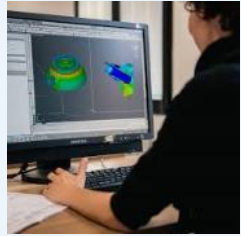
+ Laser micromachining





Unique **SOFTWARE** portfolio

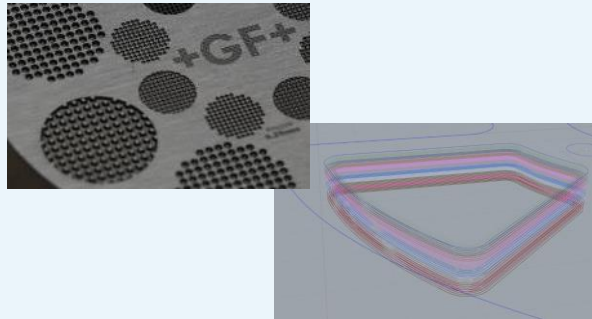
LaserSUITE360



Workstation

LaserCAM

- Engraving, cleaning
- Cutting and drilling







LaserDESIGN

- Texturing
- Structuring
- Laser Blasting



LaserTOOLBOX

-  LaserCONTROL
-  LaserSIMULATOR
-  LaserVIEWER
-  LaserPMT



Laser Machine

Laser program





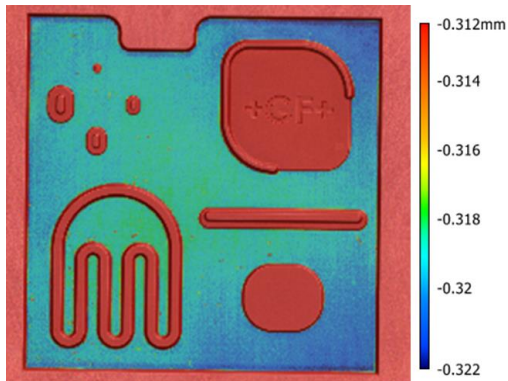
Laser micro-engraving





Laser microengraving

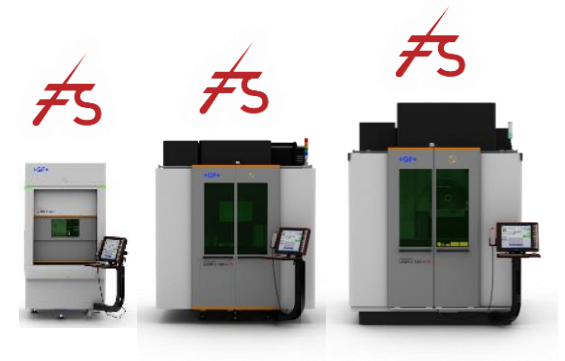
Application examples



Embossing die



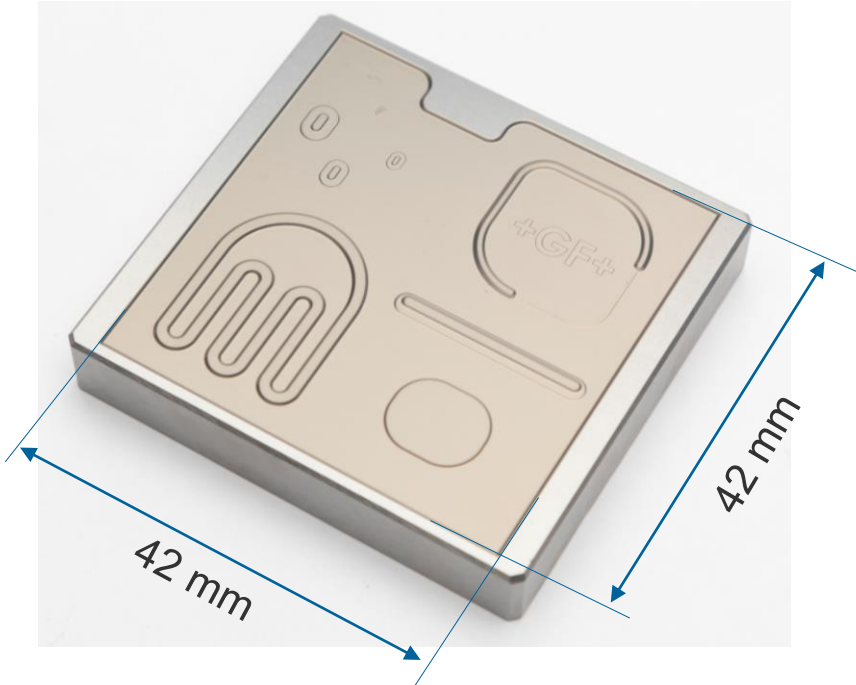
Ultrasonic welding tool



Surface chip mount inductor



Embossing die



Conditions:

- Material: Tungsten carbide (H40S).
- Starting surface: polished ($Ra < 0.1 \mu\text{m}$)
- Plate flatness: $\pm 2 \mu\text{m}$

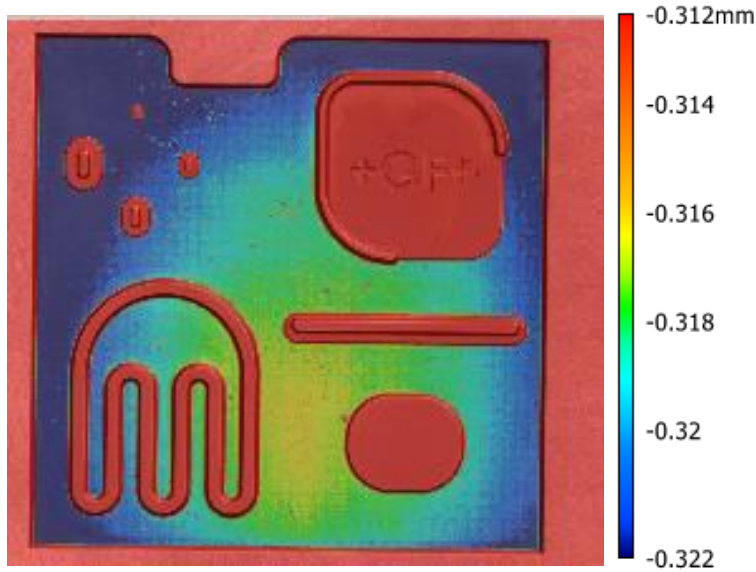
Goals:

- Target depth: 0.287 mm.
- Surface roughness $Ra < 0.40 \mu\text{m}$



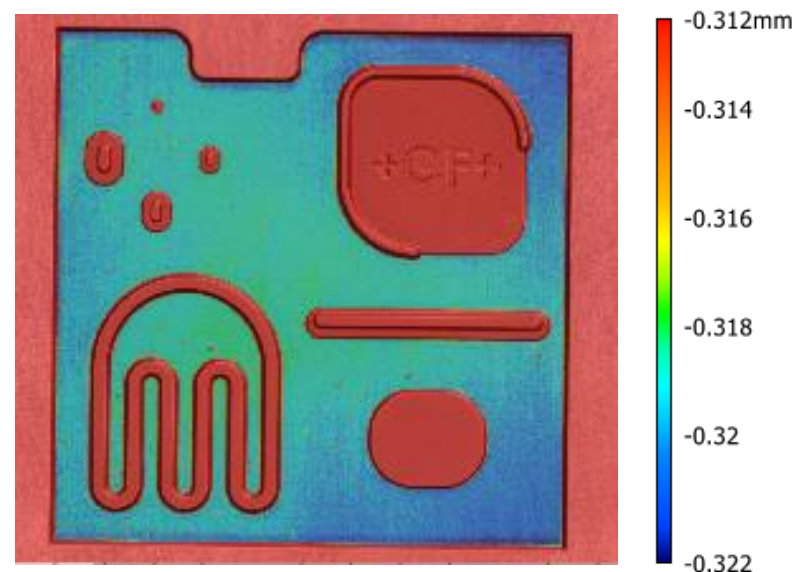
+ Embossing die Flatness measurements

Standard toolpath



Cavity flatness $\pm 7 \mu\text{m}$

Precision toolpath

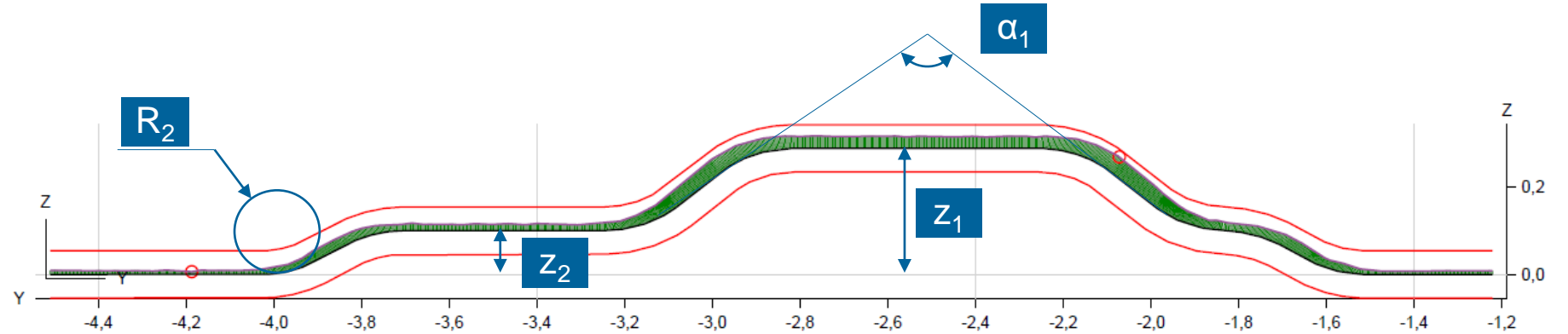
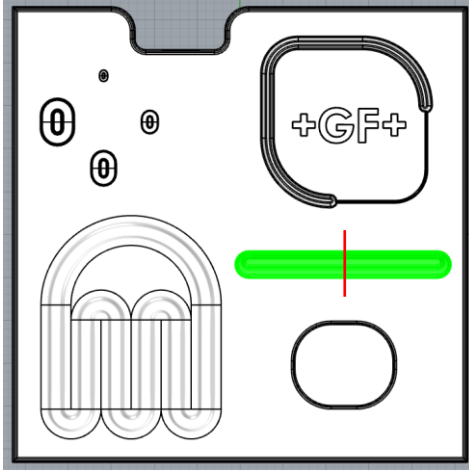


Cavity flatness $\pm 3 \mu\text{m}$





Embossing die Dimensional measurements

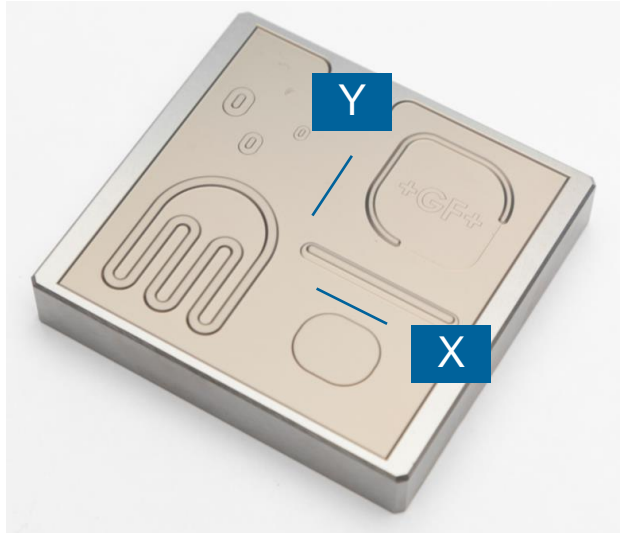


Dimension	Measurement	CAD	Delta
α_1	39.035 deg	38.237 deg	0.798 deg
Z_1	0.1145 mm	0.1000 mm	0.0145 mm
Z_2	0.3117 mm	0.2870 mm	0.0247 mm
R_2	0.2641 mm	0.2770 mm	-0.0129 mm



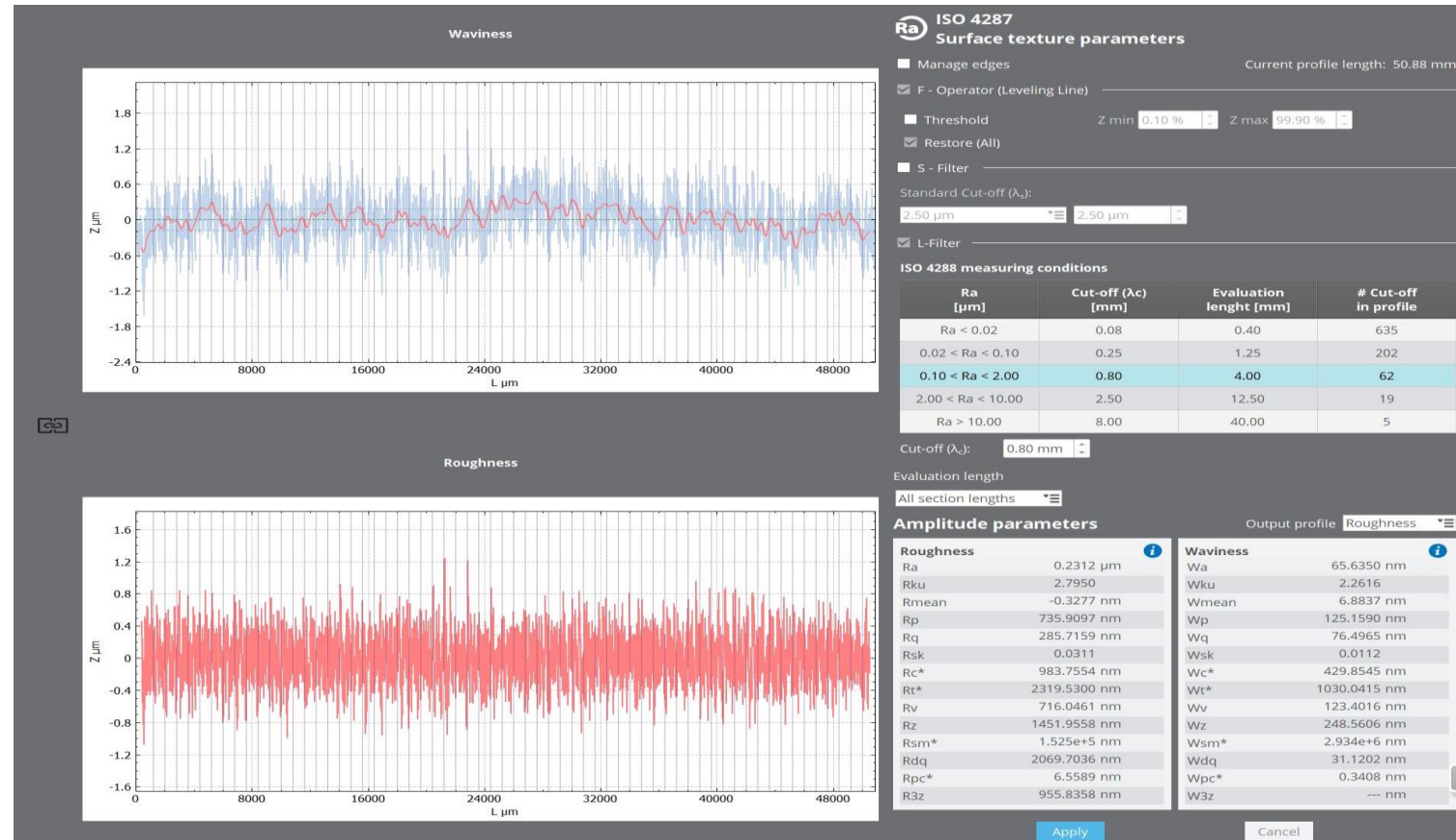


Embossing die Surface roughness measurements



Measured values:

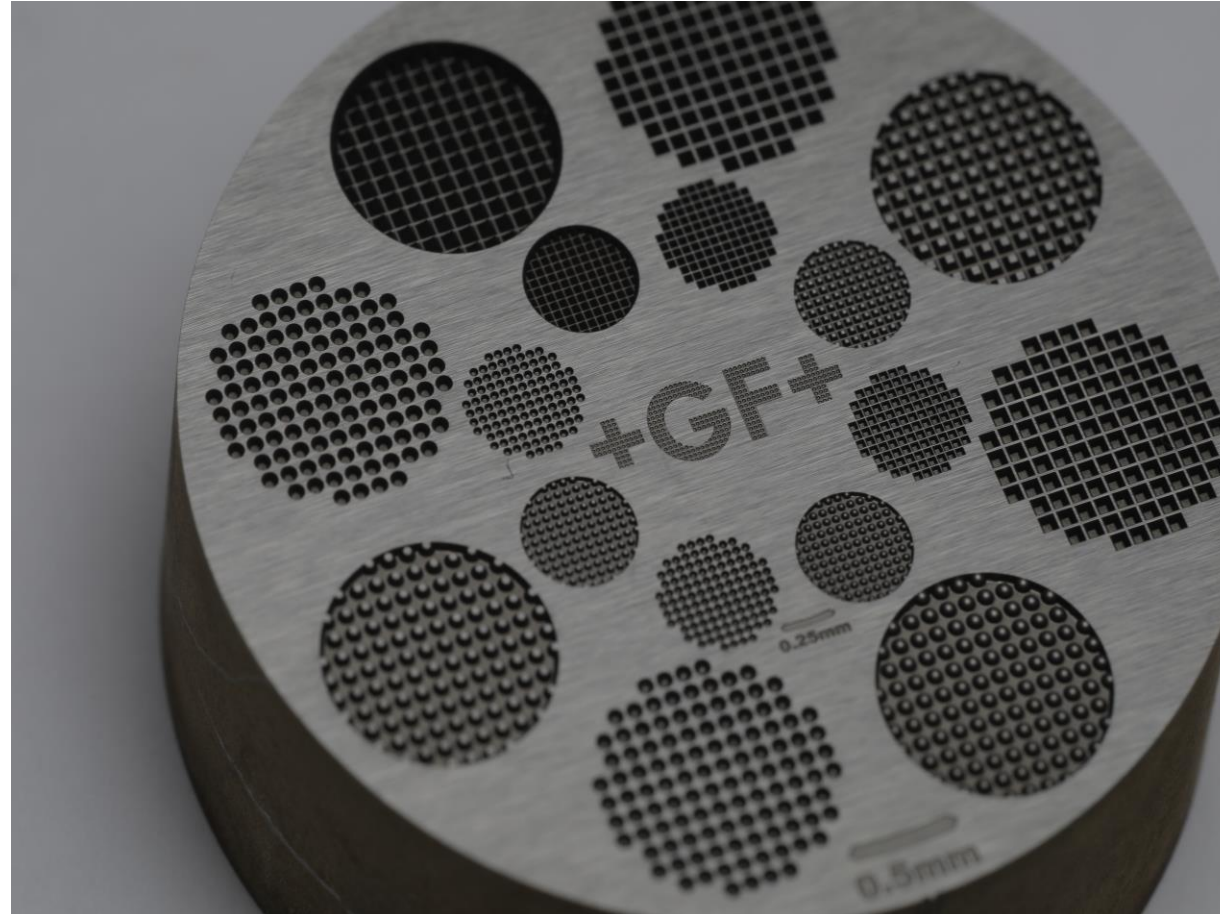
- Ra on X = 0.231 μm
- Ra on Y = 0.233 μm



SENSOFAR
METROLOGY

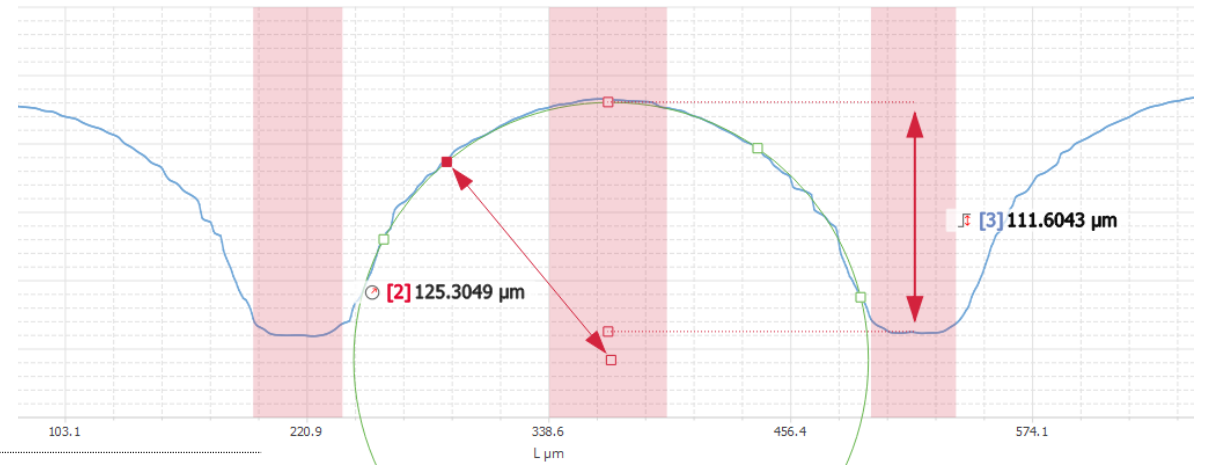
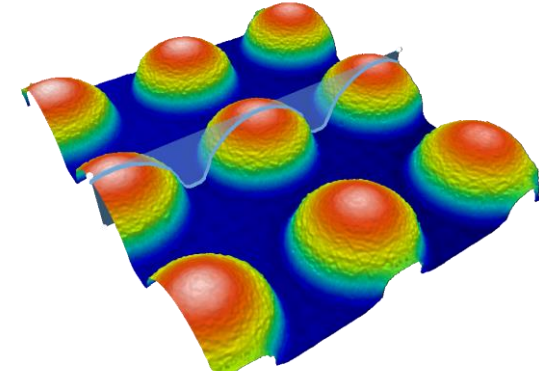
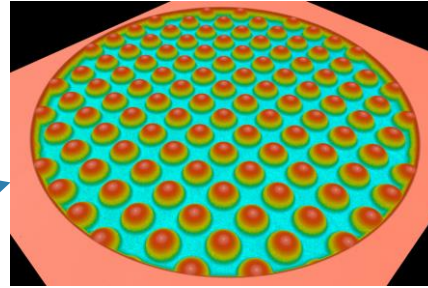


Micro-patterns on tungsten carbide





Micro-patterns on tungsten carbide



Dimension	Measurement	CAD	Delta
Radius	0.1253 mm	0.1250 mm	0.0003 mm
Depth	0.1116 mm	0.1125 mm	-0.0009 mm





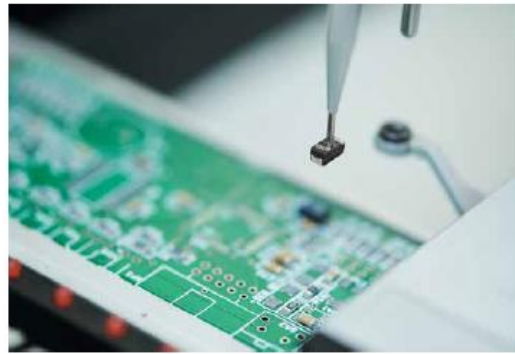
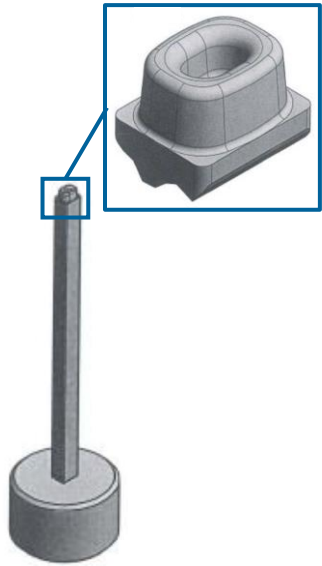
Industry case

Roughing Laser, finishing DS EDM





Industry case: Manufacturing a surface chip mount inductor



Challenge:

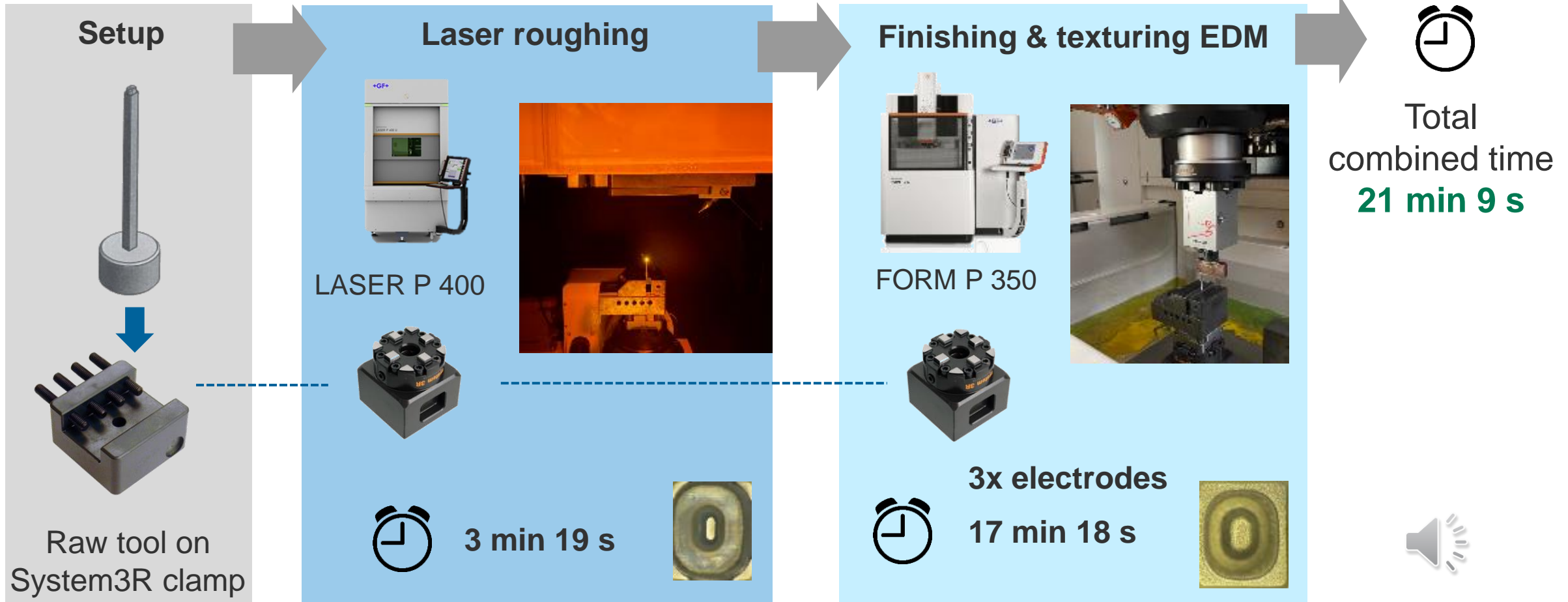
- Tooling now requires two types of electrodes
- Electrodes made of WCu
- Shape accuracy required: $\pm 10 \mu\text{m}$

	EDM Electrodes required	Machining time
Roughing & finishing EDM	6 electrodes per tool	34 min 17 sec per tool
Roughing Laser Finishing EDM	3 electrodes per tool	21 min 9 sec per tool





Industry case: Synergy Laser / EDM / System 3R

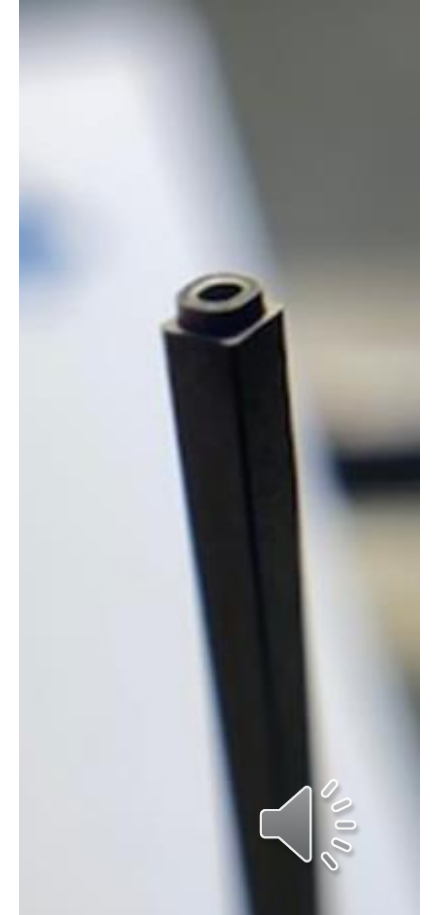




Industry case: **Synergy Laser / EDM / System 3R**

Customer benefits:

- **38%** shorter manufacturing time.
- **Excellent machining accuracy:**
 - Depth $\pm 2.5 \mu\text{m}$
 - Lateral size $\pm 3.5 \mu\text{m}$
- **High repositioning accuracy** with **System3R** chuck.
- **50%** less electrodes required



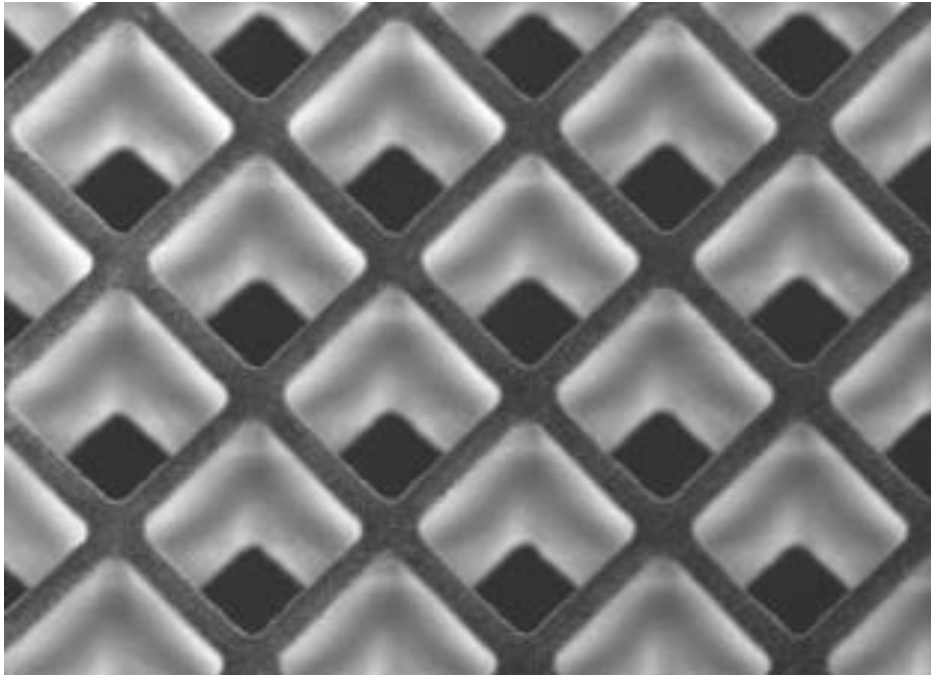
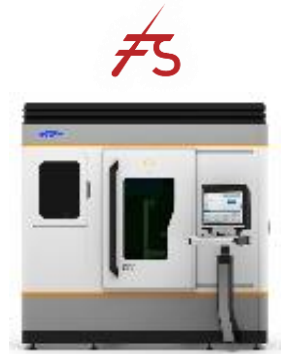
Laser micro-cutting and micro-drilling





Laser micro-drilling and micro-cutting

Application examples



Laser drilling of probe card guide

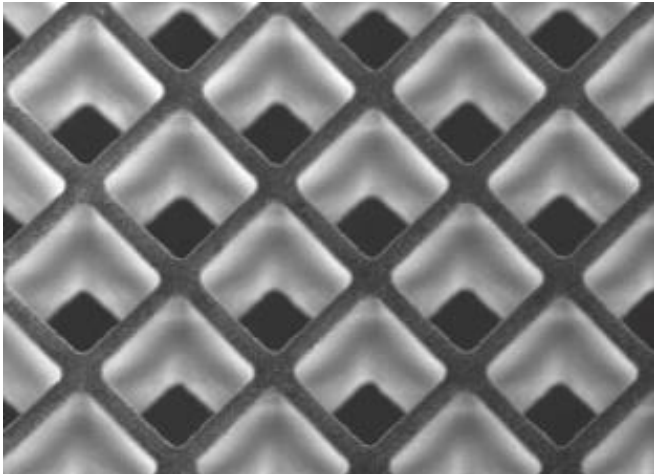


Watchmaking: movement part

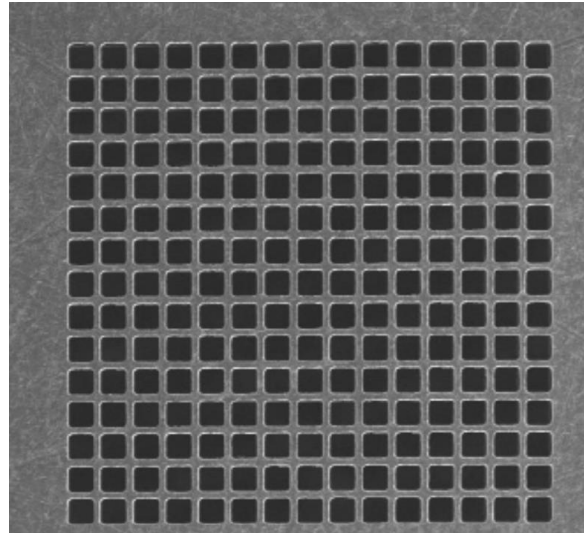




Laser drilling of probe card guide



- 35 μm x 35 μm through 300 μm SiN
- 7 μm wall thickness
- 3.5 μm corner radii

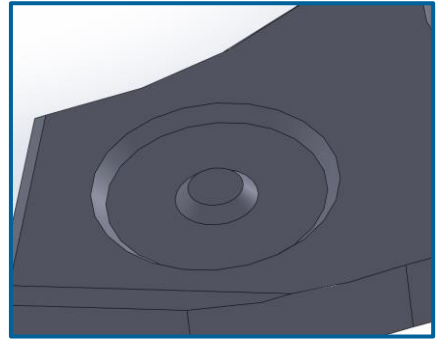


- Positioning accuracy $< \pm 3 \mu\text{m}$
- Minimum distance between adjacent holes $< 7 \mu\text{m}$
- Minimum hole size: 30 x 30 μm
- Hole size accuracy $< \pm 0.6 \mu\text{m}$
- Corner radii on rectangular holes $\leq 4 \mu\text{m}$
- Aspect ratio 1:10
- Material thickness: ~ 400 μm typical

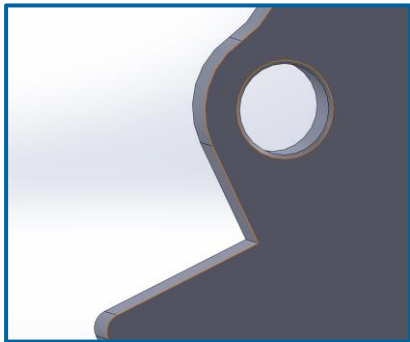




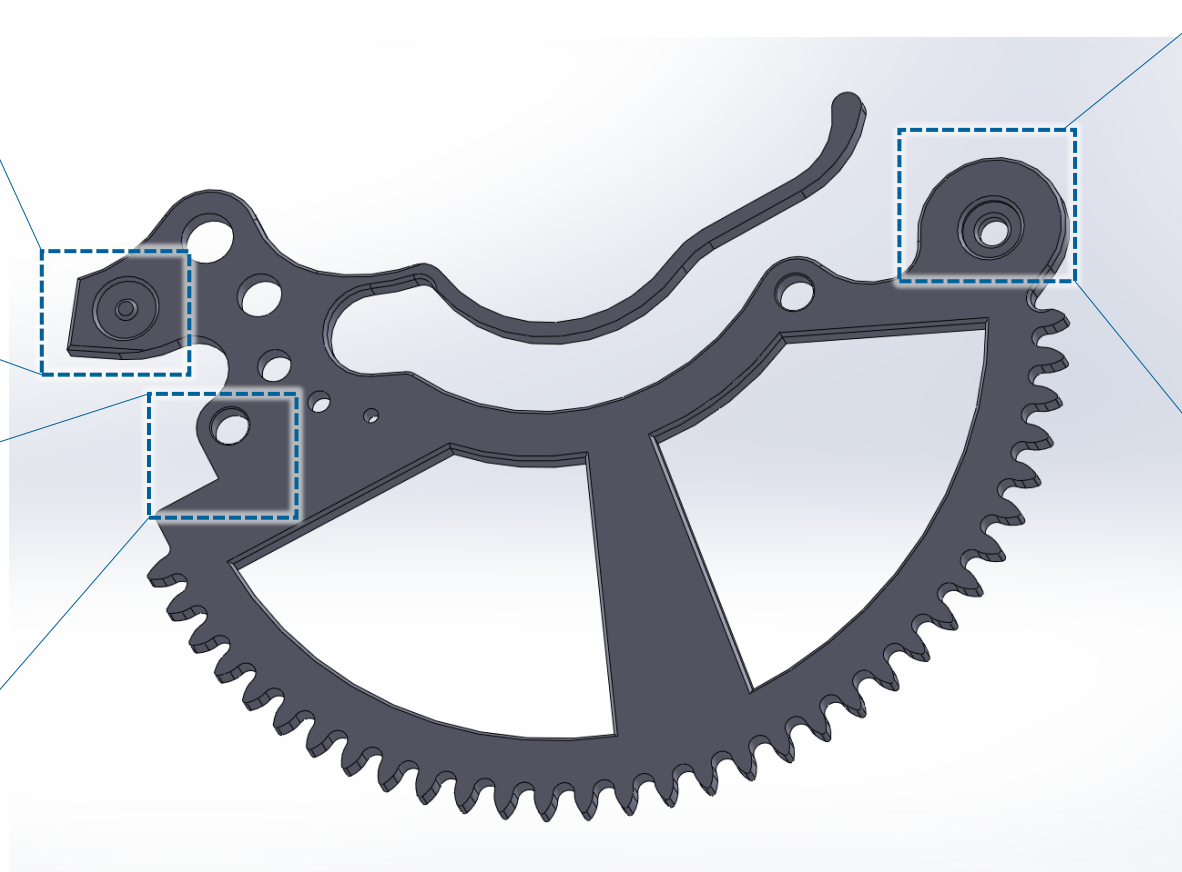
Watchmaking: movement part (13 x 10 mm)



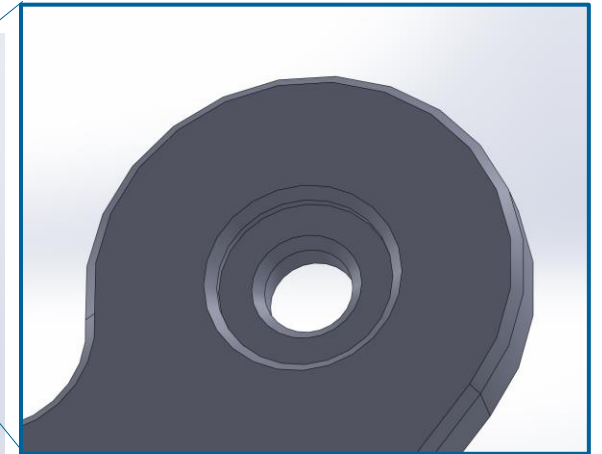
Blind cavity
Ø 0.8 mm, 0.05 mm deep



Straight wall cutting
30 µm corner radius



Durnico, 0.3 mm thick



Counterbore: Ø 0.8 mm, 0.1 mm deep
Chamfering: 20 µm at 45°
Hole: Ø 0.8 mm, 0° taper





Microlution ML-5

Demo watch part, 13 x 10 mm



- Machining time: 20 min 32 s
- Programming time: ~ 1 h 30 min*



**Material, thickness, quality and operations are known and validated beforehand.*



Key takeaways

- GF Machining Solutions is a key supplier of Laser micromachining equipment.
- Complete micromachining portfolio.
- Global company, local support.
- Proprietary CAM solutions for maximum quality and productivity.
- Possible to combine Laser with traditional manufacturing technologies to obtain the best results.





Thank you for your attention

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GF Machining Solutions





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